

Docket No.: I433.107.101/13217

10-22-2004



102866055

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copy(ies) thereof.

1. Name of conveying party(ies):

Andreas Jakobs;
Hermann Ruckerbauer; and
Maksim Kuzmenka

2. Name and address of receiving party(ies):

Name: Infineon Technologies AG

Internal Address:

Street Address: St. Martin Str. 53

City: Munich

State:

ZIP: 81541

Country: Germany

Additional name(s) & addresses attached?

☐ Yes ☒ No

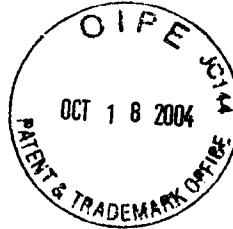
Additional name(s) of conveying party(ies) attached?

☒ No ☐ Yes

3. Nature of conveyance:

☒ Assignment ☐ Merger
☐ Security Agreement ☐ Change of Name
☐ Other _____

Execution Date: August 26, 2004; August 23, 2004; and August 31, 2004



4. Application number(s) or patent number(s):

If this document is being filed together with a new application, the execution date of the application is: _____

A. Patent Application Serial No.(s)/Filing Date(s)

10/886,814 July 8, 2004

B. Patent No.(s)

Additional numbers attached? ☐ Yes ☒ No

5. Name and address of party to whom correspondence concerning document should be mailed:

Name: Paul P. Kempf

6. Total number of applications and patents involved: 1

7. Total fee (37 CFR 3.41). . \$40.00

☐ Enclosed.☒ The Patent Office is hereby authorized to charge Deposit Acct. No. 50-0471 in the amount of \$40.00 for recording of the Assignment document.☒ Any deficiencies in enclosed fees should be charged to deposit account 50-0471.Address: DICKE, BILLIG & CZAJA, PLLC
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9. Statement and signature.

To the best of my knowledge and belief, the foregoing information is true and correct and any attached copy is a true copy of the original document.

Paul P. Kempf

(Name of Person Signing)

Signature

Date

Total number of pages comprising cover sheet, attachments and document: 4

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PATENT
REEL: 015902 FRAME: 0246

ASSIGNMENT

For good and valuable consideration, I, Andreas Jakobs, a citizen of Germany, residing at St.-Veit-Str. 57 A, 81673 München, Germany; Hermann Ruckerbauer, a citizen of Germany, residing at Veilchenstraße 1, 94554 Moos, Germany; and Maksim Kuzmenka, a citizen of Russia, residing at Stockerweg 17, 81829 München, Germany, hereinafter individually or collectively referred to as "Assignor";

Hereby sell, assign and transfer to **Infineon Technologies AG**, a corporation organized and existing under the laws of Germany, having its principal place of business at St. Martin Str. 53, 81541, Munich, Germany, hereinafter "Assignee", its successors, assigns and legal representatives, the entire right, title and interest in and for the United States and all foreign countries, in and to any and all improvements which are disclosed in the application for United States Letters Patent, which has been executed by the undersigned and

filed on July 8, 2004

US. Serial No. 10/886,814.

entitled: SEMICONDUCTOR MEMORY MODULE

and in and to said application and all divisional, continuing, substitute, renewal, reissue, and all other applications for Letters Patent which have been or shall be filed in the United States and all foreign countries on any of said improvements; and in and to all original and reissued patents which have been or shall be filed in the United States and all foreign countries on said improvements;

Agree that said Assignee may apply for and receive Letters Patent for said improvements in its own name; and that, when requested, without charge to but at the expense of said Assignee, its successors, assigns and legal representatives, to carry out in good faith the intent and purpose of this assignment, the undersigned will execute all divisional, continuing, substitute, renewal, reissue, and all other patent applications on any and all said improvements; execute all rightful oaths, assignments, powers of attorney and other papers; communicate to said Assignee, its successors, assigns, and legal representatives, all facts known to the undersigned relating to said improvements and the history thereof; and generally do everything possible which said Assignee, its successors, assigns or legal representatives shall consider desirable for aiding in securing and maintaining proper patent protection for said improvements and for vesting title to said improvements and all applications for patents and all patents on said improvements, in said Assignee, its successors, assigns and legal representatives; and

Covenant with said Assignee, its successors, assigns and legal representatives that no assignment, grant, mortgage, license or other agreement affecting the rights and property herein conveyed has been made to others by the undersigned, and that full right to convey the same as herein expressed is possessed by the undersigned.

SIGNATURE: _____

NAME: Andreas Jakobs

DATE: _____

08/26/04

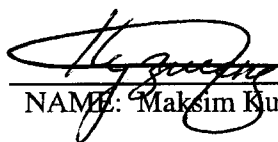
SIGNATURE: Hermann Ruckerbauer DATE: 08/23/04
NAME: Hermann Ruckerbauer

SIGNATURE: _____ DATE: _____
NAME: Maksim Kuzmenka

SIGNATURE: _____ DATE: _____

NAME: Hermann Ruckerbauer

SIGNATURE: _____



NAME: Maksim Kuzmenka

DATE: _____

31 Aug 2004